	PATENT
Dkt. No.	

## **DECLARATION AND POWER OF ATTORNEY**

As a below-named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

the specification of whi	ch	:				
(check one)		:	•	•		
· · · · -	X is attached here	eto				
· _	was filed on		,,	as		
·	Application Serial N	lo				
a	ind was amended or		,,	•		
	`.	(if applicabl	e)			
I hereby state that I ha including the claims, as				above-identific	ed specification	n,
I acknowledge the duty to be material to the pat						ne
I hereby claim foreign possible 365(b) of any foreign as International Application I have also identified International Applications claimed:	application(s) for pa n which designated a below any foreign	atent or inven at least one co n application	tor's certificate, untry other than for patent or	or Section 365 the United Statinventor's cert	(a) of any PC tes, listed below ificate, or PC	CT w.
Prior Foreign Application	on(s)			Priority Cla	imed	
<u>Number</u>	Country	<u>Fili</u>	ng Date	Yes	<u>No</u>	
JP2002 274914	JAPAN	Sep.	20,2002	<u>x</u>		
-JP2003-016077	JAPAN	Jan	24,2003	<u>X</u>		
I hereby claim the ben provisional application Provisional Application	(s) listed below:	, United State  Filing Date		n 119(e) of an <u>Stat</u>		es
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Dkt. No.	

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States Application(s), or Section 365(c) of any PCT International Application(s) designating the United States listed below. Insofar as this application discloses and claims subject matter in addition to that disclosed in any such prior Application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56, which became available between the filing date(s) of such prior application(s) and the national or PCT international filing date of this application:

Application Serial No.	Filing Date		<u>Status</u>	
· ·		*	• .	
		:		
		<del></del> .		·

And I hereby appoint:

Donald S. Dowden, Reg. No. 20,701; Ivan S. Kavrukov Reg. No. 25,161; Christopher C. Dunham Reg. No. 22,031; Jay H. Maioli, Reg. No. 27,213; William E. Pelton, Reg. No. 25,702; Robert D. Katz, Reg. No. 30,141; and each of them, all c/o Cooper & Dunham LLP of 1185 Avenue of the Americas, New York, NY 10036 (Tel: 212-278-0400), my attorneys, each with full power of substitution and revocation, to prosecute this application, to make alterations and amendments therein, to receive the patent, to transact all business in the Patent and Trademark Office connected therewith and to file any International Applications which are based thereon under the provisions of the Patent Cooperation Treaty.

Please address all communications, and direct all telephone calls, regarding this application to

Donald S. Dowden Reg. No. 20,701
Cooper & Dunham LLP
1185 Avenue of the Americas
New York, N.Y. 10036
Tel. (212) 278-0400

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

6	Full name of sole or first joint inventor	OGAWA Masanor	i	<u>-</u>	
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joint inventor (if any)		<i>—</i>		
Inventor's signature	<i>6</i>	-		
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Post Office Address	·		•	
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Full name of			·	
joint inventor (if any)	. 13		,	•
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Full name of				٠
joint inventor (if any)	*			
Inventor's signature		-	•	
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